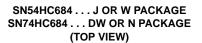
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- Wide Operating Voltage Range of 2 V to 6 V
- High-Current Outputs Drive Up To 10 LSTTL Loads
- Low Power Consumption, 80-μA Max I<sub>CC</sub>

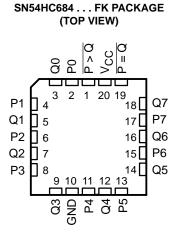


		_	
P > Q [		20	V <sub>CC</sub>
P0 [		19	P = Q
Q0 [	3	18	] Q7
P1 [	4	17	P7
Q1 [	5	16	Q6
P2 [	6	15	P6
Q2 [	7	14	Q5
P3 [	8	13	P5
Q3 [	9	12	Q4
GND [	10	11	P4

# Low Input Current of 1 $\mu$ A Max Compare Two 8-Bit Words

 $\pm$ 4-mA Output Drive at 5 V

Typical t<sub>pd</sub> = 22 ns



#### description/ordering information

These magnitude comparators perform comparisons of two 8-bit binary or BCD words. These devices provide
$\overline{P} = Q$ and $\overline{P} > Q$ outputs.

	TA	PACK	AGE <sup>†</sup>	ORDERABLE PART NUMBER	TOP-SIDE MARKING								
		PDIP – N	Tube	SN74HC684N	SN74HC684N								
	$-40^{\circ}C$ to $85^{\circ}C$	SOIC - DW	Tube	SN74HC684DW	HC684								
		3010 - 010	Tape and reel	SN74HC684DWR	HC004								
		CDIP – J	Tube	SNJ54HC684J	SNJ54HC684J								
	–55°C to 125°C	CFP – W	Tube	SNJ54HC684W	SNJ54HC684W								
		LCCC – FK	Tube	SNJ54HC684FK	SNJ54HC684FK								

#### **ORDERING INFORMATION**

<sup>†</sup> Package drawings, standard packing quantities, thermal data, symbolization, and PCB design guidelines are available at www.ti.com/sc/package.

#### FUNCTION TABLE

OUTPUTS					
P = Q	<b>P &gt; Q</b>				
L	Н				
н	L				
н	н				
	<b>P = Q</b> L H				

generated by applying  $\overline{P} = Q$ and  $\overline{P} > Q$  to a 2-input NAND gate.



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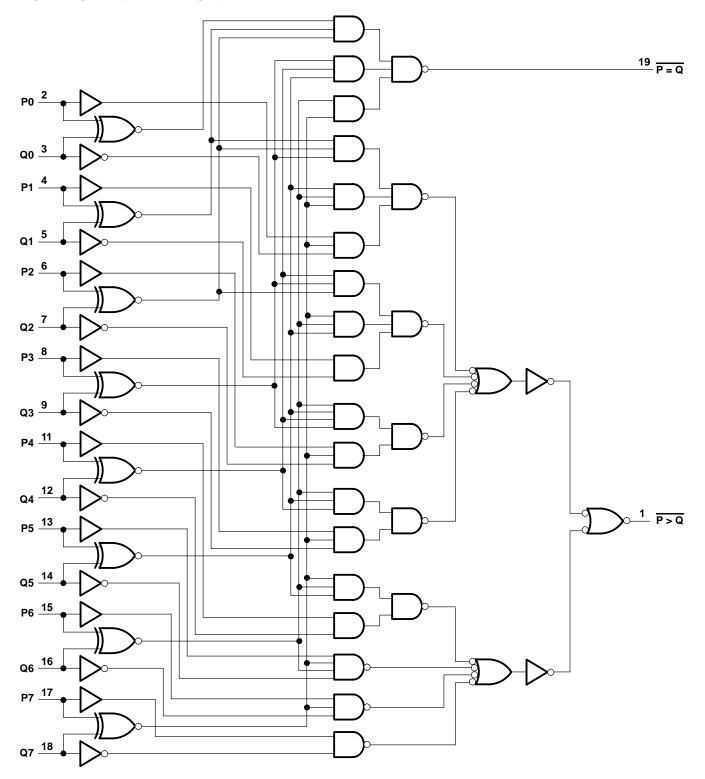
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## logic diagram (positive logic)





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#### absolute maximum ratings over operating free-air temperature range (unless otherwise noted)<sup>†</sup>

Supply voltage range, $V_{CC}$ Input voltage range, $V_I$ (see Note 1) Output voltage range, $V_O$ (see Note 1) Input clamp current, $I_{IK}$ ( $V_I < 0$ or $V_I > V_{CC}$ ) Output clamp current, $I_{OK}$ ( $V_O < 0$ or $V_O > V_{CC}$ ) Continuous output current, $I_O$ ( $V_O = 0$ to $V_{CC}$ ) Continuous current through $V_{CC}$ or GND Package thermal impedance, $\theta_{JA}$ (see Note 2): DW package	$\begin{array}{c} -0.5 \ \text{V to } 7 \ \text{V} \\ \dots -0.5 \ \text{V to } V_{\text{CC}} + 0.5 \ \text{V} \\ \dots & \pm 20 \ \text{mA} \\ \dots & \pm 20 \ \text{mA} \\ \dots & \pm 25 \ \text{mA} \\ \dots & \pm 50 \ \text{mA} \\ \dots & 58^{\circ}\text{C/W} \end{array}$
Storage temperature range, T <sub>stg</sub>	69°C/W

<sup>+</sup> Stresses beyond those listed under "absolute maximum ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under "recommended operating conditions" is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

NOTES: 1. The input and output voltage ratings may be exceeded if the input and output current ratings are observed.

2. The package thermal impedance is calculated in accordance with JESD 51-7.

#### recommended operating conditions (see Note 3)

			SN	SN54HC684			SN74HC684			
			MIN	NOM	MAX	MIN	NOM	MAX	UNIT	
Vcc	Supply voltage		2	5	6	2	5	6	V	
		$V_{CC} = 2 V$	1.5			1.5				
VIH	High-level input voltage	$V_{CC} = 4.5 V$	3.15			3.15			V	
		ACC = 6 A	4.2		W	4.2				
		$V_{CC} = 2 V$		0.5				0.5		
VIL	Low-level input voltage	$V_{CC} = 4.5 V$		2	1.35			1.35	V	
		ACC = 6 A		5	1.8			1.8		
VI	Input voltage		0	50	VCC	0		VCC	V	
Vo	Output voltage		0	)`	VCC	0		VCC	V	
		$V_{CC} = 2 V$	Q		1000			1000		
tt	Input transition (rise and fall) times	V <sub>CC</sub> = 4.5 V		500			500	ns		
		VCC = 6 V			400			400		
ТА	Operating free-air temperature		-55		125	-40		85	°C	

NOTE 3: All unused inputs of the device must be held at V<sub>CC</sub> or GND to ensure proper device operation. Refer to the TI application report, *Implications of Slow or Floating CMOS Inputs*, literature number SCBA004.



SCLS340B – MARCH 1996 – REVISED MARCH 2003

electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

PARAMETER	TEST CO	Vee	Т	A = 25°C	;	SN54F	IC684	SN74HC684		UNIT			
PARAMETER	1231 60	VCC	MIN	TYP	MAX	MIN	MAX	MIN	MAX	UNIT			
					2 V	1.9	1.998		1.9		1.9		
		l <sub>OH</sub> = -20 μA	4.5 V	4.4	4.499		4.4		4.4				
VOH	$V_I = V_{IH} \text{ or } V_{IL}$		6 V	5.9	5.999		5.9		5.9		V		
		I <sub>OH</sub> = -4 mA	4.5 V	3.98	4.30		3.7	W	3.84				
		I <sub>OH</sub> = -5.2 mA	6 V	5.48	5.80		5.2	N.	5.34				
	VI = VIH or VIL		2 V		0.002	0.1		0.1		0.1			
		I <sub>OL</sub> = 20 μA	4.5 V		0.001	0.1	, k	0.1		0.1			
VOL			6 V		0.001	0.1	$\gamma_{0}$	0.1		0.1	V		
		I <sub>OL</sub> = 4 mA	4.5 V		0.17	0.26	04	0.4		0.33			
		I <sub>OL</sub> = 5.2 mA	6 V		0.15	0.26	Q	0.4		0.33			
Чн	$V_{I} = V_{CC}$		6 V		0.1	100		1000		1000	nA		
۱ <sub>IL</sub>	$V_{I} = 0$		6 V		-0.1	-100		-1000		-1000	nA		
ICC	$V_I = V_{CC} \text{ or } 0,$	IO = 0	6 V			8		160		80	μA		
Ci			2 V to 6 V		3	10		10		10	pF		

# switching characteristics over recommended operating free-air temperature range, $C_L = 50 \text{ pF}$ (unless otherwise noted) (see Figure 1)

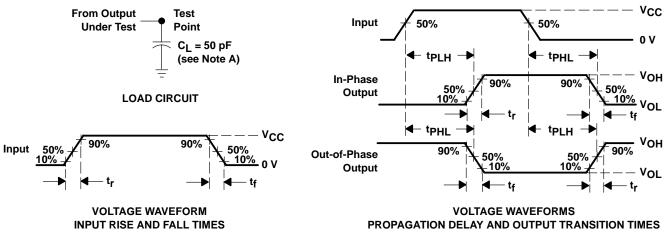
PARAMETER	FROM	то	Vaa	Т	ן = 25°C	;	SN54HC684	SN74HC684	UNIT
	(INPUT)	(OUTPUT)	Vcc	MIN	TYP	MAX	MIN MAX	MIN MAX	UNIT
		2 V		130	275	413	344		
t <sub>pd</sub> Por Q	Any	Any	4.5 V		26	55	88	69	ns
			6 V		22	47	70	58	
			2 V		38	75	\$ 110	95	
tt		Any	4.5 V		8	15	22	19	ns
			6 V		6	13	<b>2</b> 19	16	

### operating characteristics, $T_A = 25^{\circ}C$

	PARAMETER	TEST CONDITIONS	TYP	UNIT
С	pd Power dissipation capacitance	No load	40	рF



SCLS340B - MARCH 1996 - REVISED MARCH 2003



#### PARAMETER MEASUREMENT INFORMATION

NOTES: A. CL includes probe and test-fixture capacitance.

- B. Phase relationships between waveforms were chosen arbitrarily. All input pulses are supplied by generators having the following characteristics: PRR  $\leq$  1 MHz, Z<sub>O</sub> = 50  $\Omega$ , t<sub>r</sub> = 6 ns. t<sub>f</sub> = 6 ns.
- C. The outputs are measured one at a time with one input transition per measurement.
- D.  $t_{PLH}$  and  $t_{PHL}$  are the same as  $t_{pd}$ .

#### Figure 1. Load Circuit and Voltage Waveforms





#### PACKAGING INFORMATION

Orderable Device	Status (1)	Package Type	Package Drawing	Pins	Package Qty	Eco Plan (2)	Lead finish/ Ball material	MSL Peak Temp (3)	Op Temp (°C)	Device Marking (4/5)	Samples
SN74HC684DW	ACTIVE	SOIC	DW	20	25	RoHS & Green	NIPDAU	Level-1-260C-UNLIM	-40 to 85	HC684	Samples
SN74HC684N	ACTIVE	PDIP	Ν	20	20	RoHS & Non-Green	NIPDAU	N / A for Pkg Type	-40 to 85	SN74HC684N	Samples

<sup>(1)</sup> The marketing status values are defined as follows:

ACTIVE: Product device recommended for new designs.

LIFEBUY: TI has announced that the device will be discontinued, and a lifetime-buy period is in effect.

NRND: Not recommended for new designs. Device is in production to support existing customers, but TI does not recommend using this part in a new design.

**PREVIEW:** Device has been announced but is not in production. Samples may or may not be available.

**OBSOLETE:** TI has discontinued the production of the device.

<sup>(2)</sup> RoHS: TI defines "RoHS" to mean semiconductor products that are compliant with the current EU RoHS requirements for all 10 RoHS substances, including the requirement that RoHS substance do not exceed 0.1% by weight in homogeneous materials. Where designed to be soldered at high temperatures, "RoHS" products are suitable for use in specified lead-free processes. TI may reference these types of products as "Pb-Free".

**RoHS Exempt:** TI defines "RoHS Exempt" to mean products that contain lead but are compliant with EU RoHS pursuant to a specific EU RoHS exemption.

Green: TI defines "Green" to mean the content of Chlorine (CI) and Bromine (Br) based flame retardants meet JS709B low halogen requirements of <=1000ppm threshold. Antimony trioxide based flame retardants must also meet the <=1000ppm threshold requirement.

<sup>(3)</sup> MSL, Peak Temp. - The Moisture Sensitivity Level rating according to the JEDEC industry standard classifications, and peak solder temperature.

<sup>(4)</sup> There may be additional marking, which relates to the logo, the lot trace code information, or the environmental category on the device.

<sup>(5)</sup> Multiple Device Markings will be inside parentheses. Only one Device Marking contained in parentheses and separated by a "~" will appear on a device. If a line is indented then it is a continuation of the previous line and the two combined represent the entire Device Marking for that device.

<sup>(6)</sup> Lead finish/Ball material - Orderable Devices may have multiple material finish options. Finish options are separated by a vertical ruled line. Lead finish/Ball material values may wrap to two lines if the finish value exceeds the maximum column width.

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# PACKAGE OPTION ADDENDUM

## TEXAS INSTRUMENTS

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9-Aug-2022

## TUBE



## - B - Alignment groove width

\*All dimensions are nominal

Device	Package Name	Package Type	Pins	SPQ	L (mm)	W (mm)	Τ (μm)	B (mm)
SN74HC684DW	DW	SOIC	20	25	507	12.83	5080	6.6
SN74HC684N	N	PDIP	20	20	506	13.97	11230	4.32

# N (R-PDIP-T\*\*)

PLASTIC DUAL-IN-LINE PACKAGE

16 PINS SHOWN



NOTES:

- A. All linear dimensions are in inches (millimeters).B. This drawing is subject to change without notice.
- Falls within JEDEC MS-001, except 18 and 20 pin minimum body length (Dim A).
- $\triangle$  The 20 pin end lead shoulder width is a vendor option, either half or full width.



# **DW0020A**



# **PACKAGE OUTLINE**

## SOIC - 2.65 mm max height

SOIC



NOTES:

- 1. All linear dimensions are in millimeters. Dimensions in parenthesis are for reference only. Dimensioning and tolerancing per ASME Y14.5M. 2. This drawing is subject to change without notice. 3. This dimension does not include mold flash, protrusions, or gate burrs. Mold flash, protrusions, or gate burrs shall not
- exceed 0.15 mm per side.
- 4. This dimension does not include interlead flash. Interlead flash shall not exceed 0.43 mm per side.
- 5. Reference JEDEC registration MS-013.



# DW0020A

# **EXAMPLE BOARD LAYOUT**

## SOIC - 2.65 mm max height

SOIC



NOTES: (continued)

6. Publication IPC-7351 may have alternate designs.

7. Solder mask tolerances between and around signal pads can vary based on board fabrication site.

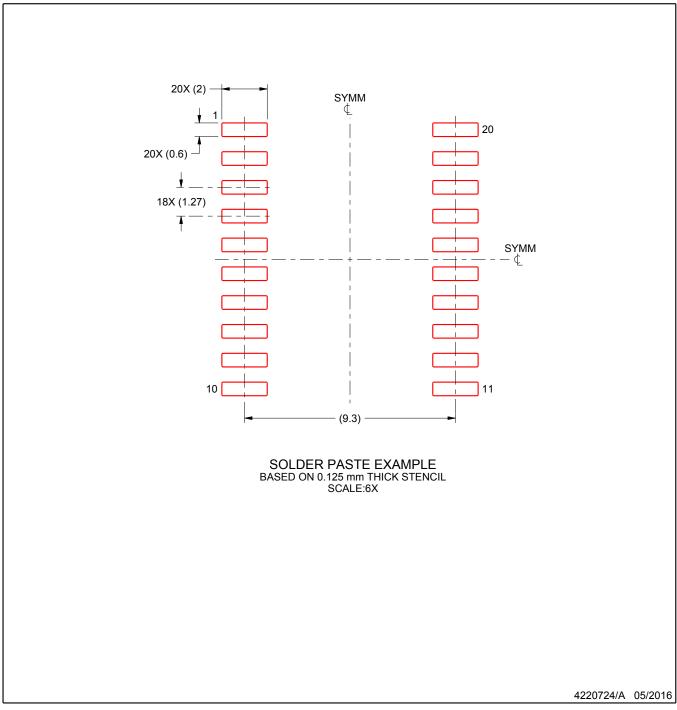


# DW0020A

# **EXAMPLE STENCIL DESIGN**

## SOIC - 2.65 mm max height

SOIC



NOTES: (continued)

- 8. Laser cutting apertures with trapezoidal walls and rounded corners may offer better paste release. IPC-7525 may have alternate design recommendations.
- 9. Board assembly site may have different recommendations for stencil design.



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